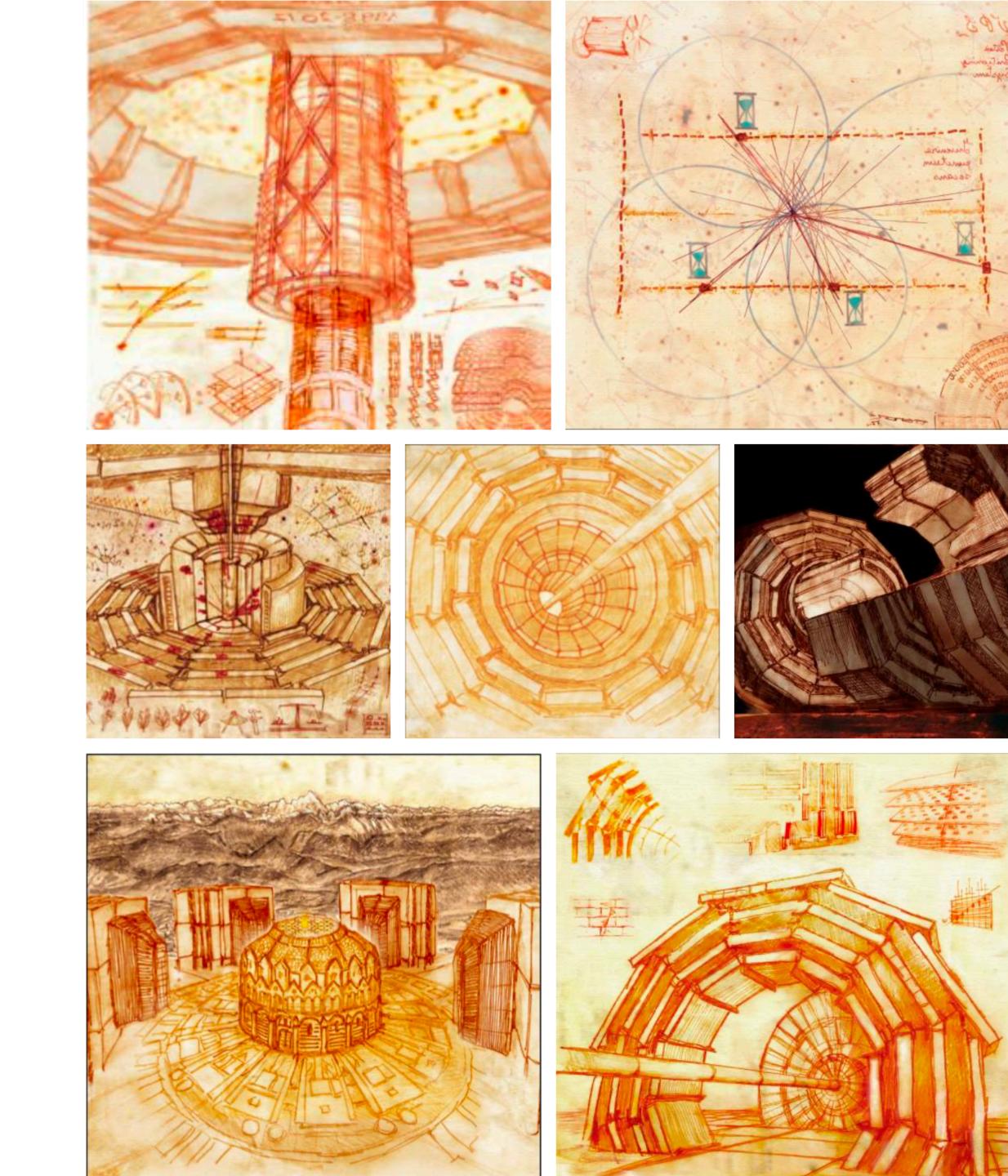


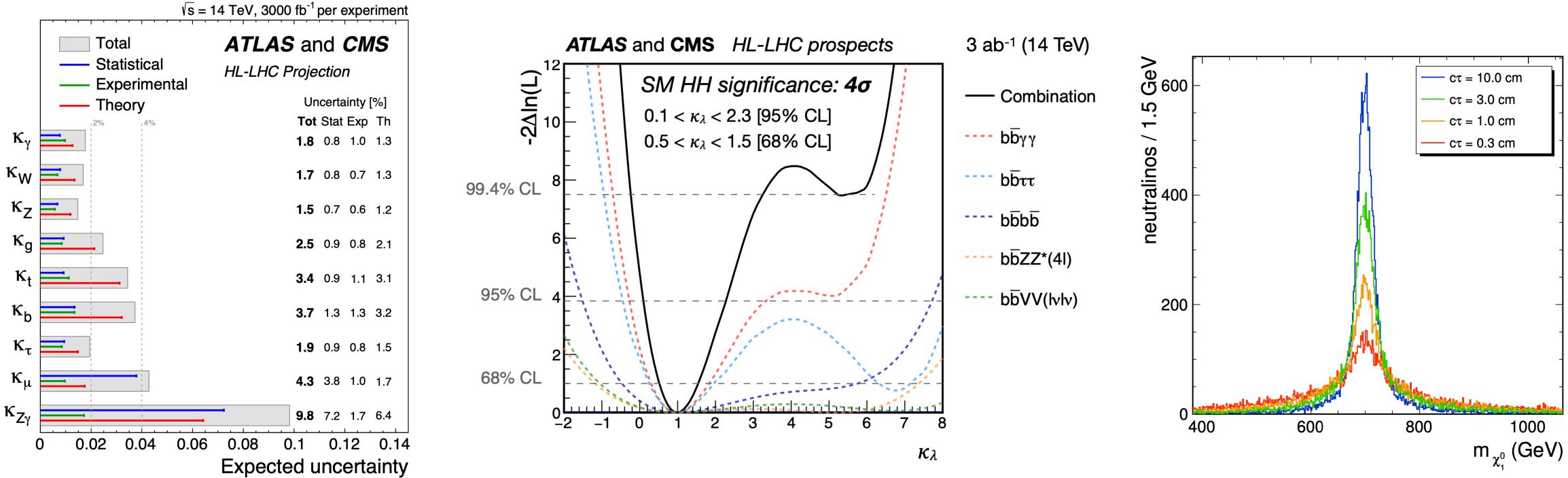
### CMS Phase2 Upgrade Higgs Hunting - 14<sup>th</sup> edition 23-25 September 2024 - Orsay Paris

Federico De Guio University of Milano-Bicocca and INFN on behalf of the CMS Collaboration



## HL-LHC: unique opportunity for a rich physics program

#### Precise measurements of the Higgs coupling



#### Learn how to exploit the detectors at best means enlarging the physics reach of the high-lumi phase Already now the 2018 projections are surpassed by large factors thanks to the refinement detectors and analysis tools! 0 0

- For the Phase2 we expect to do better than just scaling with  $\sqrt{L}$

#### **Observation of the HH production** and measurement of the Higgs self-coupling

Search for dark matter candidates, long-lived particles, new gauge bosons, new interactions, etc.



## High Lumi LHC challenges



CMS Experiment at the LHC, CERN Data recorded: 2018-Apr-17 11:26:32.973824 GM Run / Event / LS: 314475 / 10482774 / 11

Number of collisions per bunch crossing (pile-up): Phase I LHC: ~40 collisions High Luminosity LHC: 140-200 collisions

......

### • Extreme pileup

• Impacts the current CMS capability to reconstruct physics events

### Unprecedented levels of radiation exposure

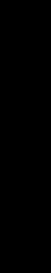
- A threat for many detector components
- ► **Goal:** integrate >3ab<sup>-1</sup> while keeping the current performance

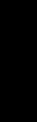
### Need for new detectors and new methods!





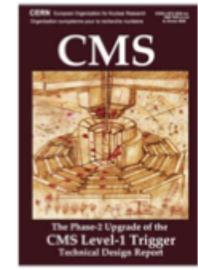








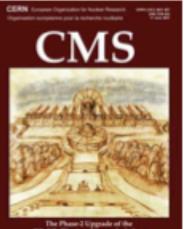
## Overview of the CMS Phase2 upgrade



### L1-Trigger

#### https://cds.cern.ch/record/2714892

- Tracks in L1-Trigger at 40 MHz
- Particle Flow selection
- 750 kHz L1 output
- 40 MHz data scouting



#### DAQ & High-Level Trigger https://cds.cern.ch/record/2759072

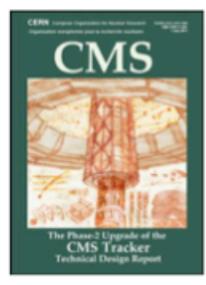
- Full optical readout Heterogenous architecture 60 TB/s event network 7.5 kHz HLT output

CMS The Phase-2 Upgrade of the CMS Endcap Calorimete

### Calorimeter Endcap

#### https://cds.cern.ch/record/2293646

- 3D showers and precise timing
- Si, Scint+SiPM in Pb/W-SS



#### Tracker

#### https://cds.cern.ch/record/2272264

- Si-Strip and Pixels increased granularity
- Design for tracking in L1-Trigger
- Extended coverage to  $\eta \simeq 3.8$

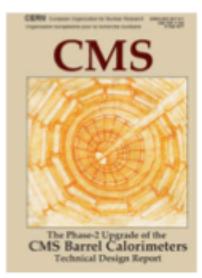
### Rad hard detectors with increases granularity and acceptance $\rightarrow$ beneficial for all analyses

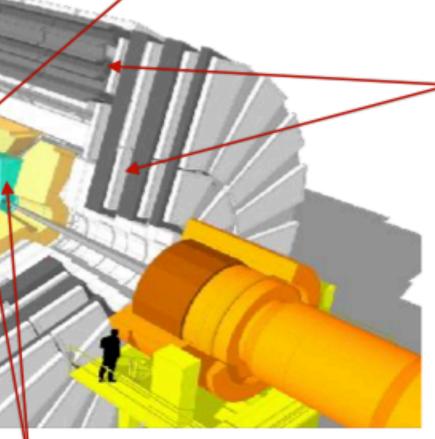
CMS

#### **Barrel Calorimeters**

#### https://cds.cern.ch/record/2283187

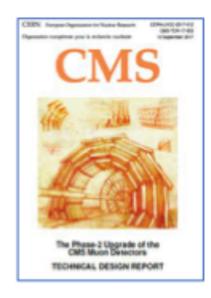
- ECAL crystal granularity readout at 40 MHz with precise timing for e/y at 30 GeV
- ECAL and HCAL new Back-End boards





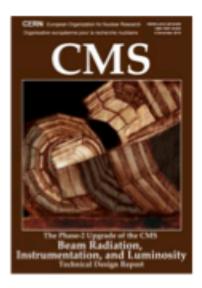
#### Muon systems https://cds.cern.ch/record/2283189

- DT & CSC new FE/BE readout
- RPC back-end electronics
- New GEM/RPC 1.6 < η < 2.4
- Extended coverage to  $\eta \simeq 3$



#### Beam Radiation Instr. and Luminosity http://cds.cern.ch/record/2759074

- Beam abort & timing
- Beam-induced background
- Bunch-by-bunch luminosity: 1% offline, 2% online
- Neutron and mixed-field radiation monitors



## **Exploit time for PU rejection and PID enabling 4D reconstruction**

### MIP Timing Detector

https://cds.cern.ch/record/2667167

Precision timing with:

- Barrel layer: Crystals + SiPMs
- Endcap layer:
- Low Gain Avalanche Diodes





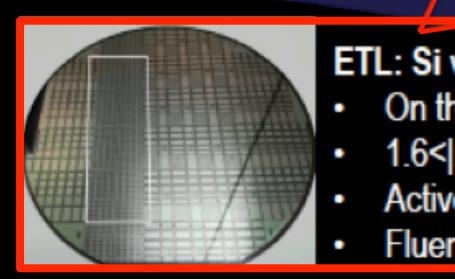
# A new timing layer: the Mip Timing Detector

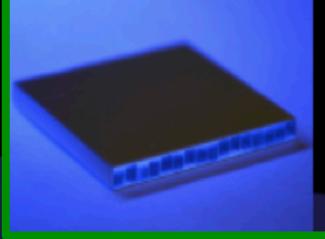
Technology choice driven by radiation hardness and costs

### **Barrel Timing Layer:** LYSO:Ce crystal bars coupled to SiPM

**Endcap Timing Layer:** Low Gain Avalanche Diodes







#### BTL: L(Y)SO bars + SiPM readout:

- TK/ ECAL interface ~ 45 mm thick
- |n|<1.45 and p<sub>T</sub>>0.7 GeV
- Active area ~38 m<sup>2</sup>; 332k channels
- Fluence at 3 ab<sup>-1</sup>: 2x10<sup>14</sup> n<sub>eg</sub>/cm<sup>2</sup>

ETL: Si with internal gain (LGAD): On the HGC nose ~ 65 mm thick 1.6<**|η|<**3.0 Active area ~14 m<sup>2</sup>; ~8.5M channels

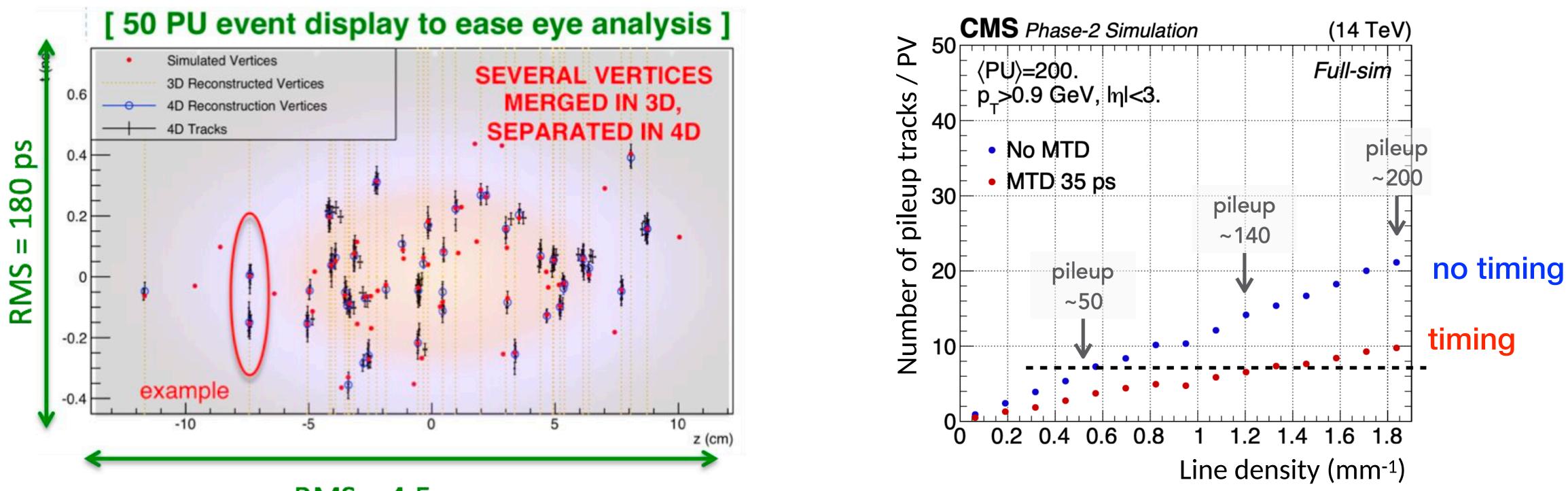
Fluence at 3 ab<sup>-1</sup>: up to 2x10<sup>15</sup> n<sub>ea</sub>/cm<sup>2</sup>





## How timing will help at the HL-LHC?

- Time-tagging of charged particles allows:
  - 4D vertex reconstruction  $\rightarrow$  resolve vertices that are close in space but separated in time
  - **Time compatibility for track-vertex association** → suppress spurious pileup tracks



RMS = 4.5 cm

Goal: 30-40 ps time resolution

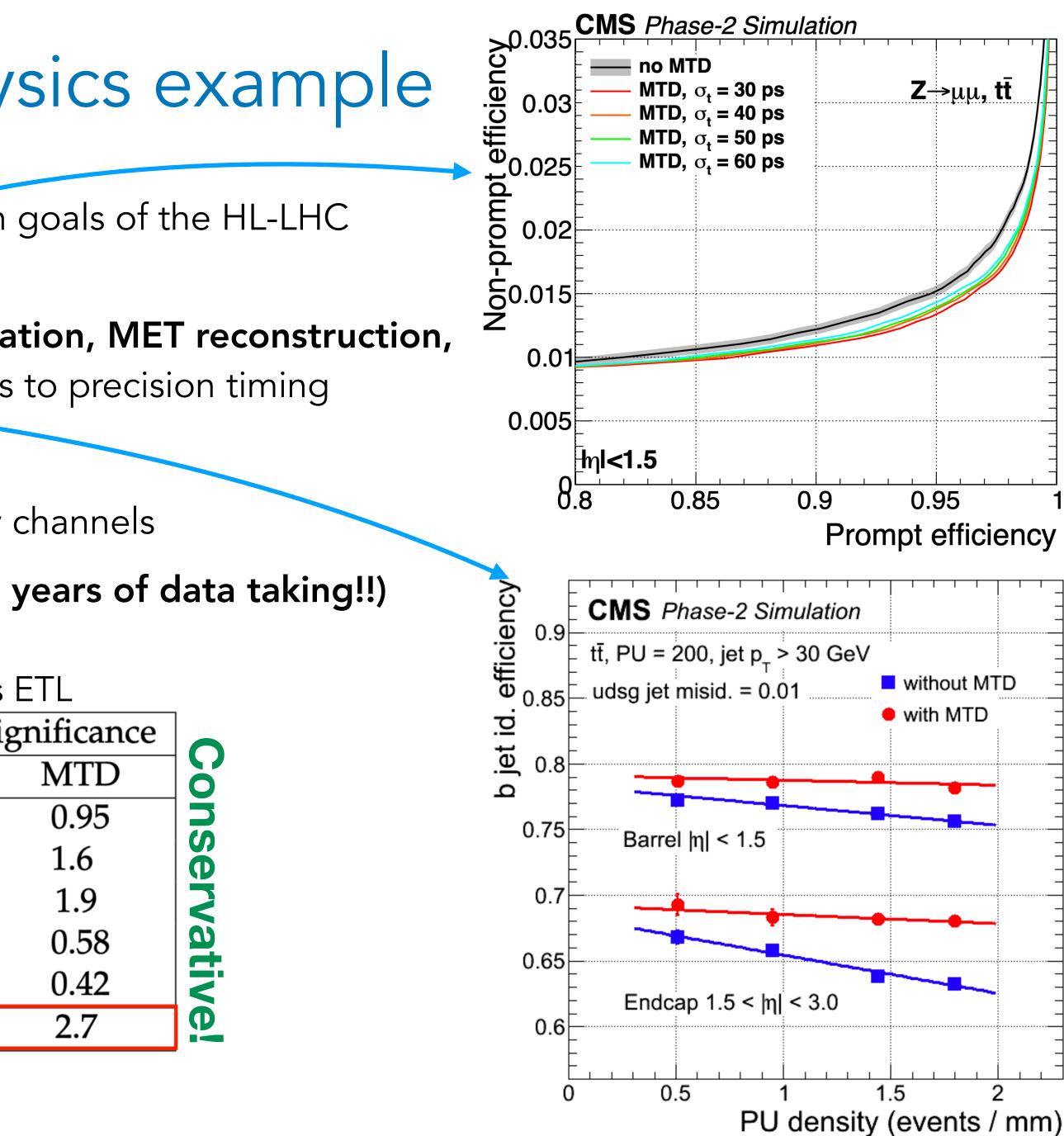




### MTD performance: one physics example

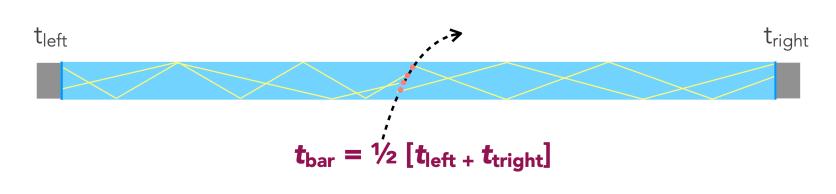
- Measure the Higgs self coupling is one of the main goals of the HL-LHC program
- Improvement to *lepton isolation, photon identification, MET reconstruction,* rejection of fake jets and b-jet ID efficiency thanks to precision timing
- → Increased signal yield for HH:
  - $\rightarrow$  10%-20% gain in s/ $\sqrt{b}$  for many Higgs decay channels
  - $\rightarrow$  equivalent to ~20-30% more luminosity (2-3 years of data taking!!)

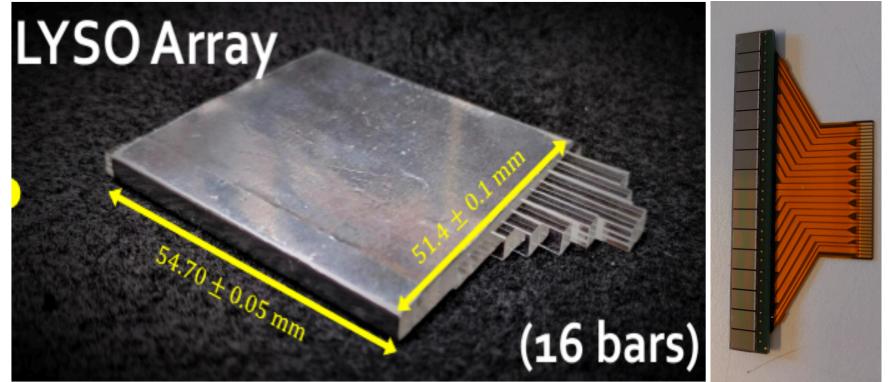
projections for 3ab <sup>-1</sup> 35ps BTL, 35ps					
	Signal increase (%)		Expected sig		
Di-Higgs decay	BTL	BTL+ETL	No MTD		
bbbb	13	17	0.88		
bbττ	21	29	1.3		
$bb\gamma\gamma$	13	17	1.7		
bbWW			0.53		
bbZZ			0.38		
Combined			2.4		



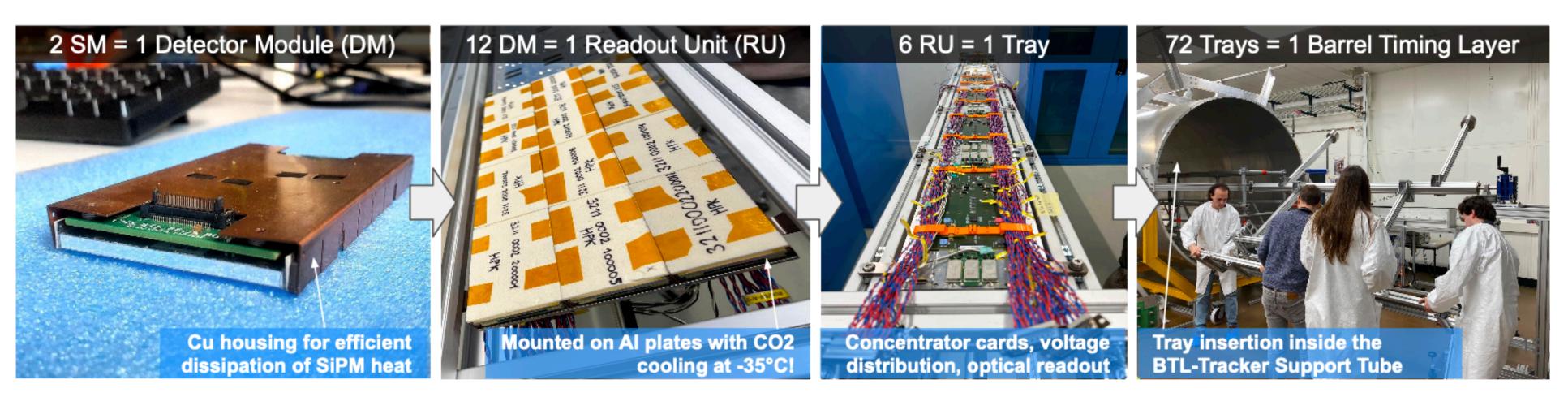


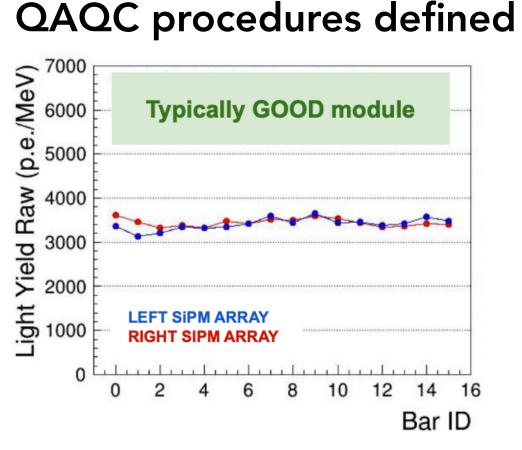
### Status: The construction of BTL has started! Fully transitioned to production







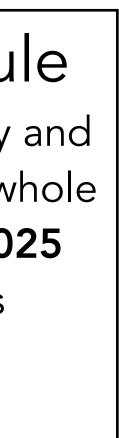




### Tight schedule

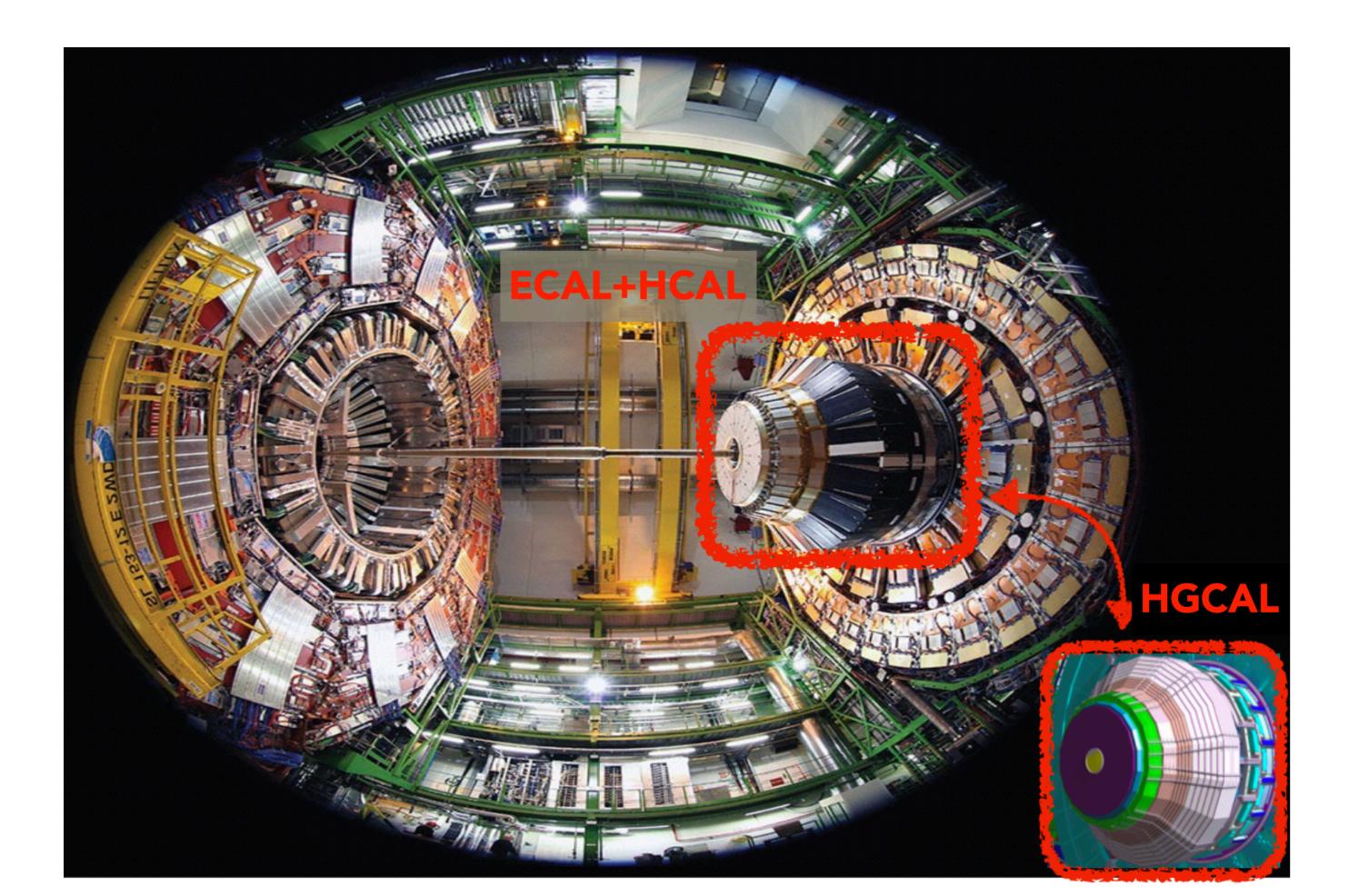
- complete assembly and integration of the whole detector by **mid 2025**
- 4 assembly centers ullet
- 72 trays in total
- 1 RU / day / AC

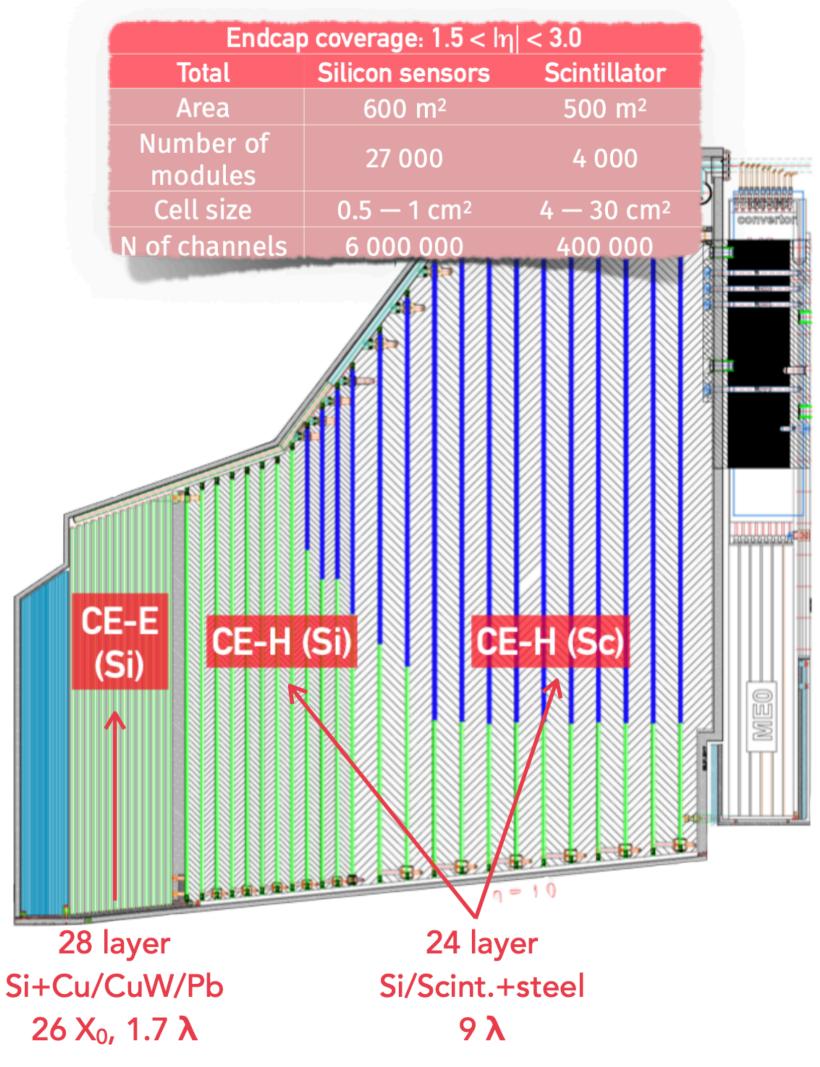






### A new high granularity calorimeter: the HGCAL • ECAL+HCAL $\rightarrow$ HGCAL (High Granularity CALorimeter) o high granularity and timing to fight PU Endcap coverage: $1.5 < |\eta| < 3.0$

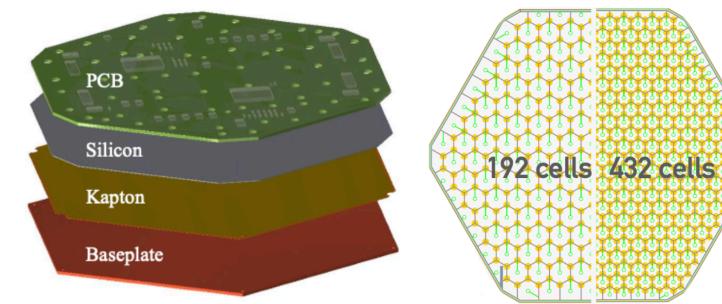


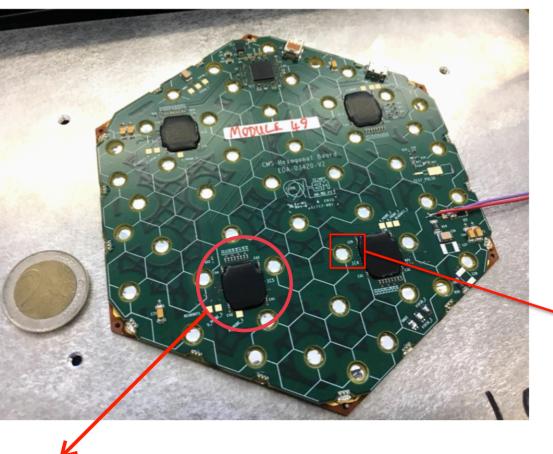




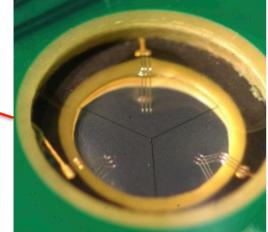
## Detector ayout module

Sensors: hexagonal silicon wafers (8") divided in cells

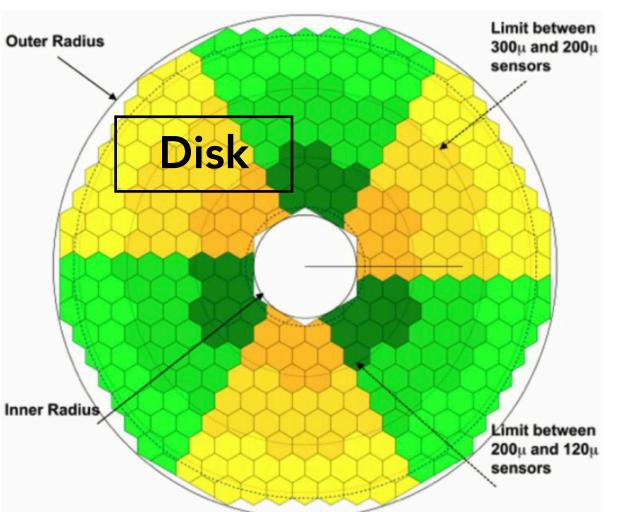




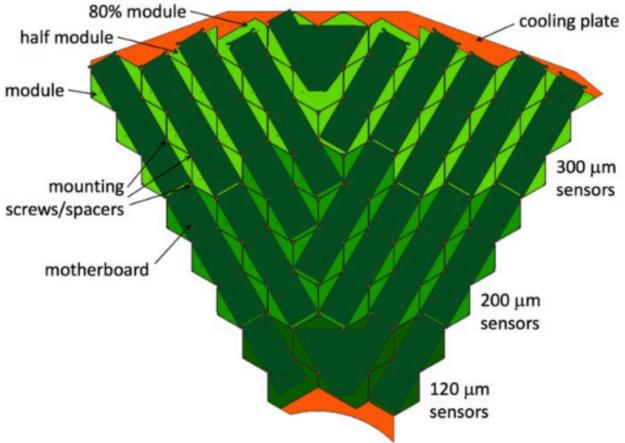
Wire bonding from PCB to silicon through holes



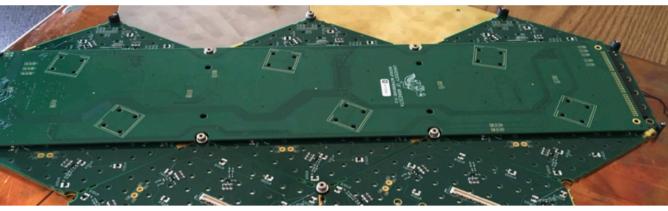


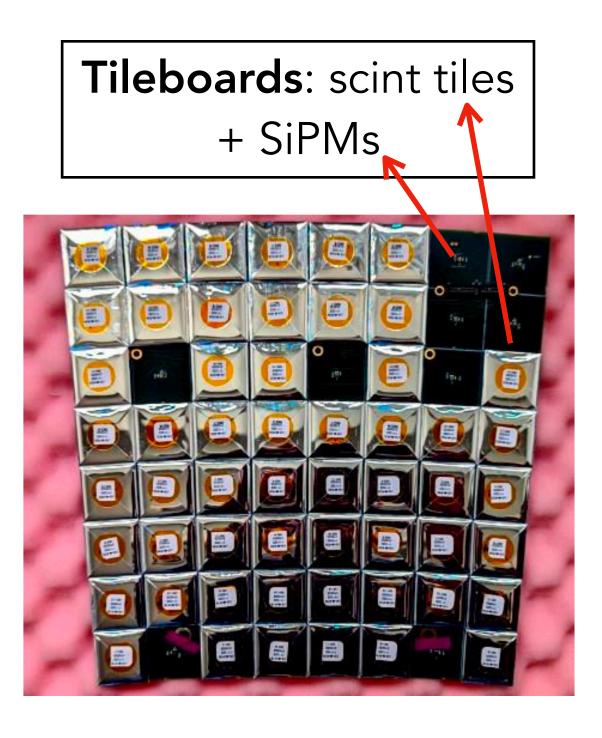


**HGCROC chip**: ToT meas. (∝amplitude) and timing (for signals >12fC, 3MIP)



### **Cassettes**: 30/60° sectors (sensors+support+motherboards)

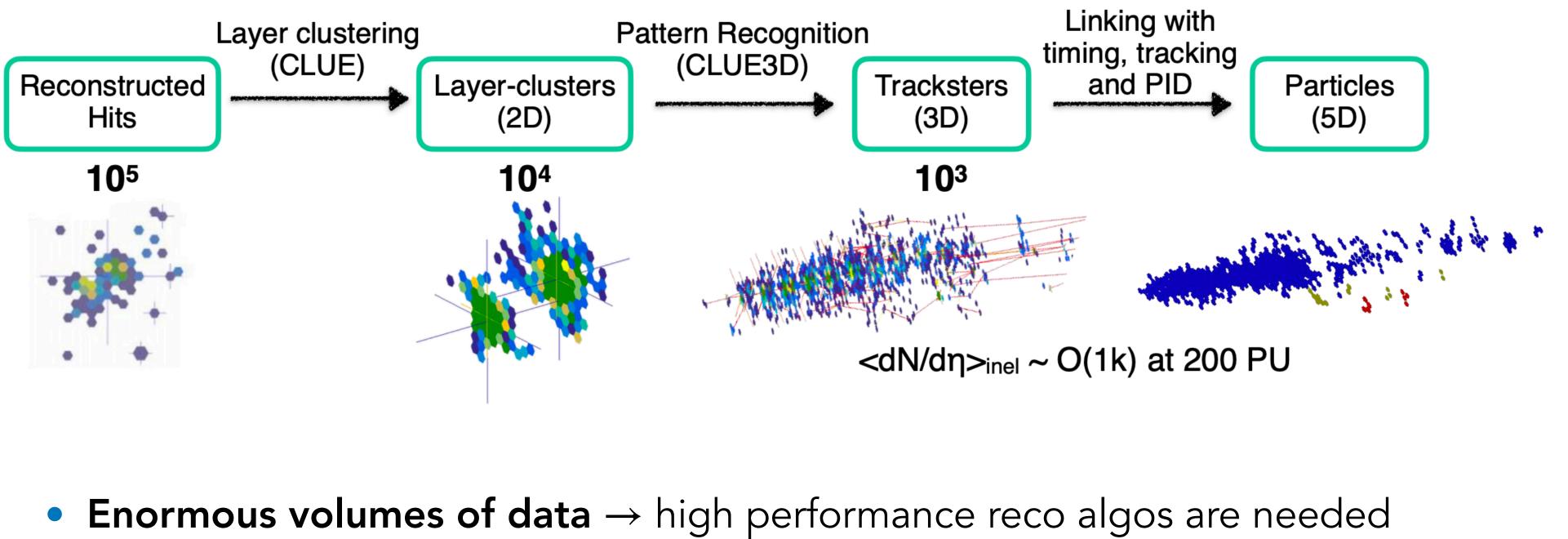








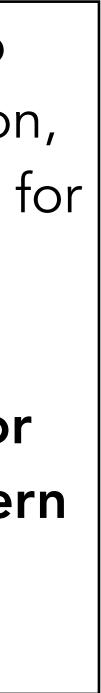
## The reconstruction challenge



- L1 accept @750 kHz rate
- DAQ at 7.5 kHz with ~ 6M channels
- Exploit heterogenous computing to maximize performance

The idea is to measure position, energy and time for each particle  $\rightarrow$  perfect playground for advanced pattern recognition techniques

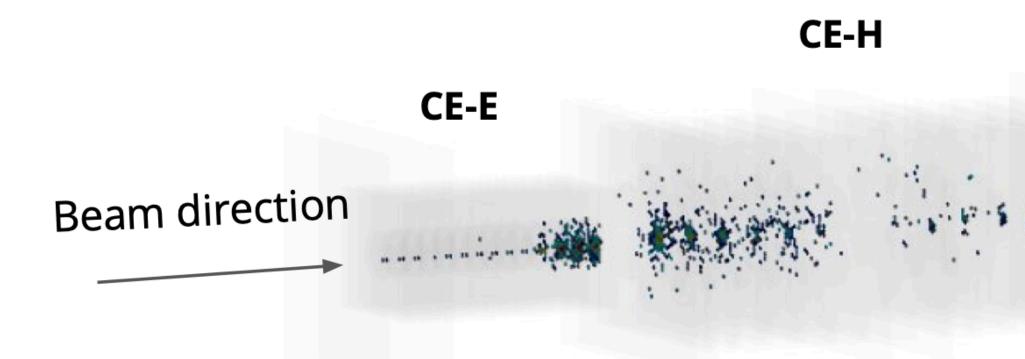
• e/γ and hadron particle showers are reconstructed from detector hits exploiting **5D information** 

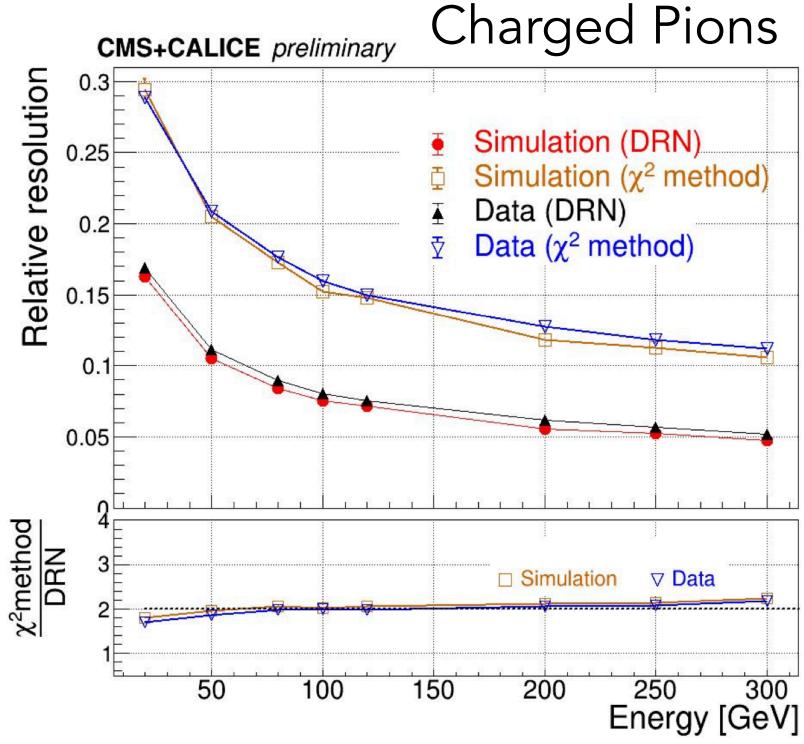


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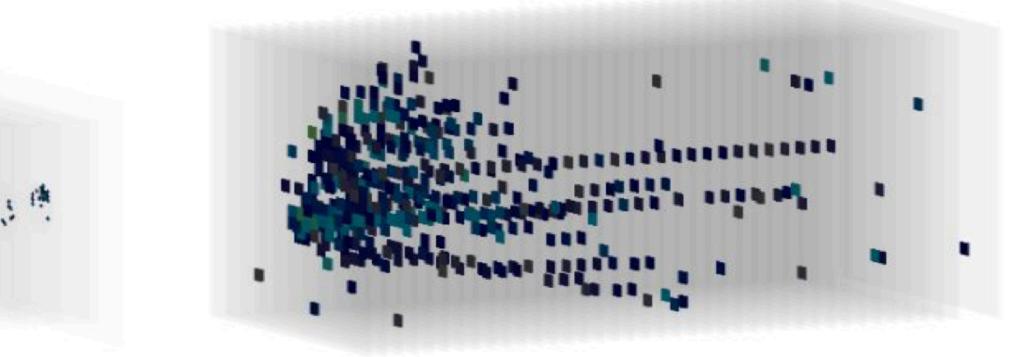
## Shower reconstruction with a prototype on beam

- Very good understanding of the setup on beam Nice data-MC agreement both for electrons and pions 0
- New ML based methods for charged pion reconstruction largely improve the resolution
  - Dynamic Reduction Network, based on GNNs
  - Exploit inputs such as energy and full 3D coordinates







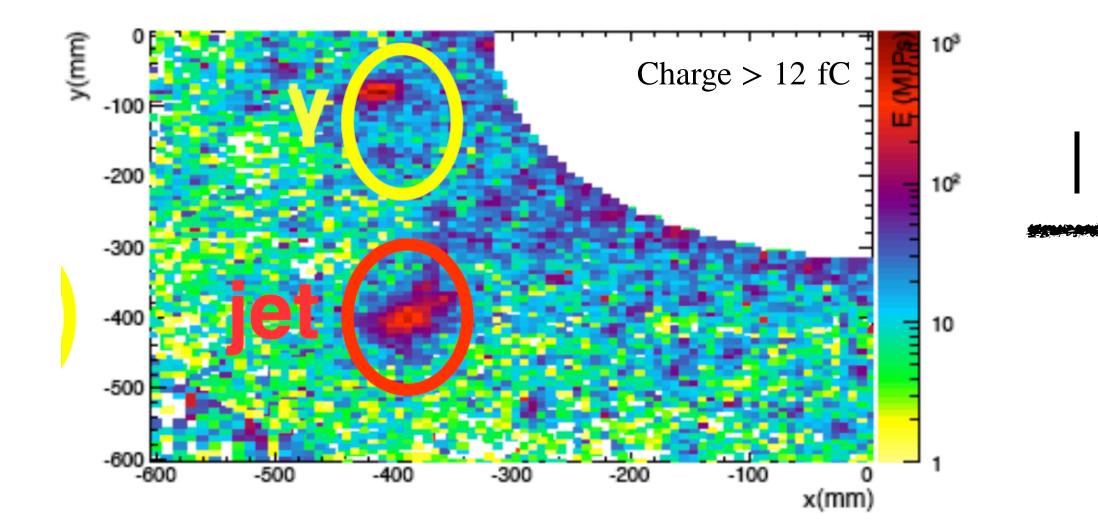


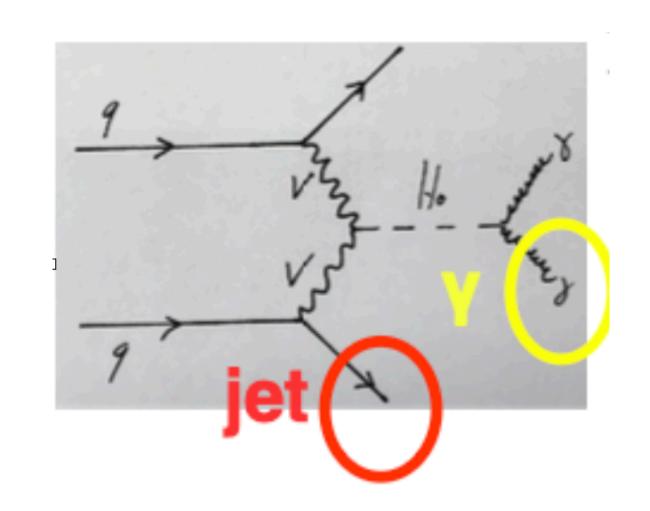




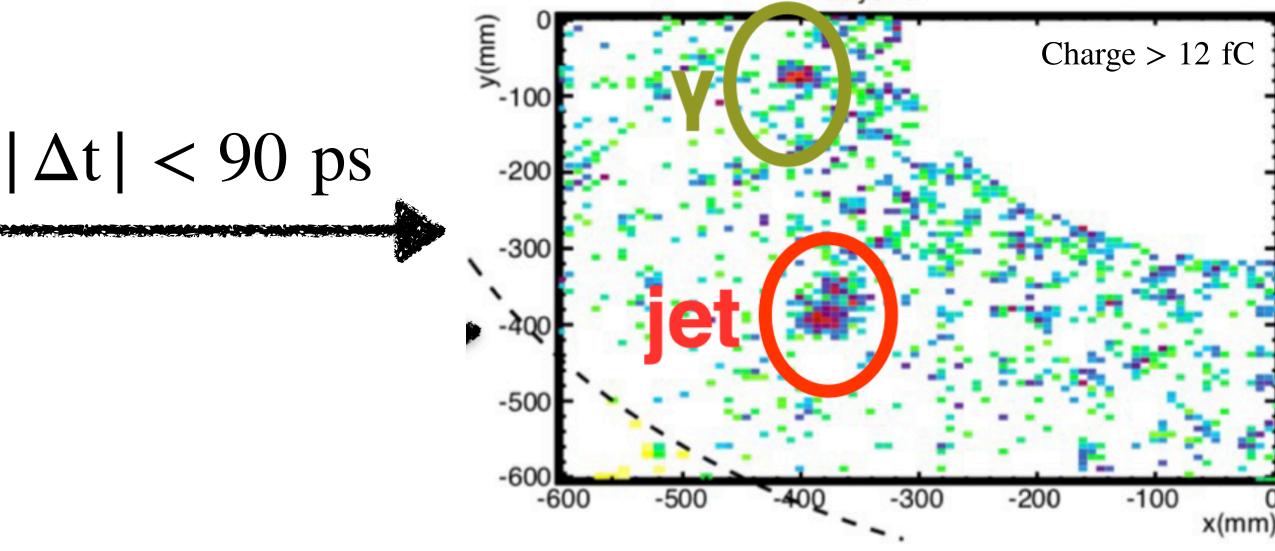
## HGCAL in action on a VFB H $\rightarrow \gamma\gamma$ event

High spatial granularity to separate objects Timing to **mitigate pileup** 

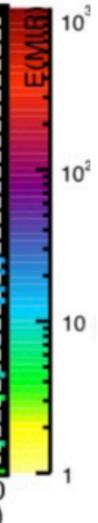




Layer 8









# Summary

High luminosity needed for searches and precision measurements

Keep (and improve) he high performance delivered in Phase-1 0

 $\rightarrow$  A lot of construction expected in 2025!

• As a consequence, very harsh conditions are expected at the HL-LHC

## The CMS Phase2 upgrade will allow us to profit from the HL-LHC era

Many detector are in the last phases of the R&D or moving to production

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Backup slides

# State of the CMS upgrade

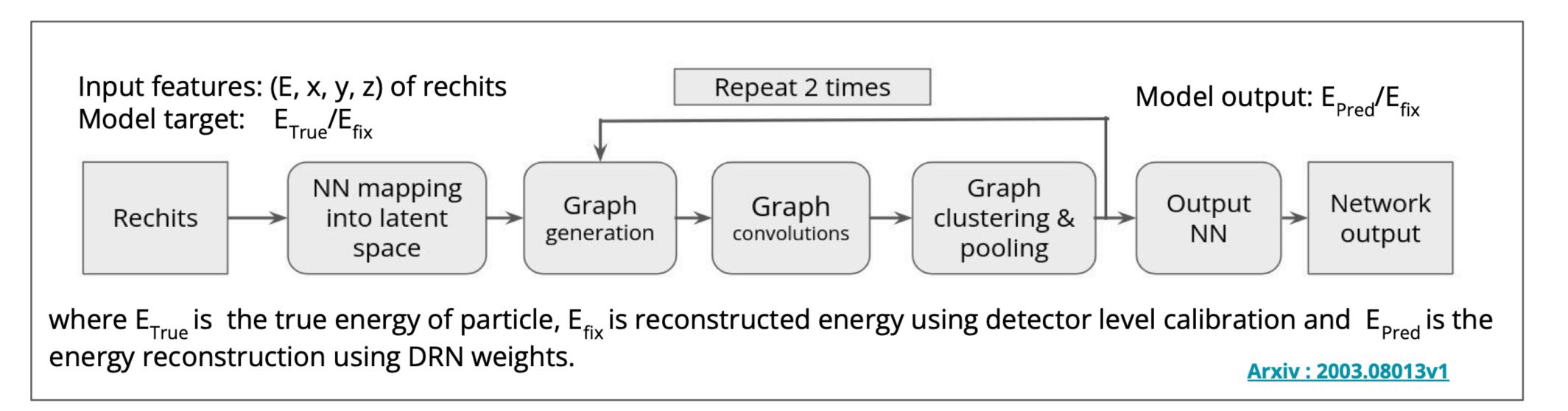
- Tracker
  - Outer Tracker: about to start module production
  - Inner Tracker: ASIC final and in production
- HGCAL
  - Considerable progress on mechanics SiPM, scintillator production started – 40% of the sensors received 0
- MTD
  - Barrel: started module production 0
  - Endcap: sensor procurement review in July; ASIC functionality proven Ο
- Muon Detector
  - RPC and GEM chambers production ongoing



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## Dynamic Reduction Network (DRN)

Based on dynamic graph neural network, a model is defined which maps input features onto a higher dimensional latent space, and adds clustering and pooling steps to aggregate information. Energies (E) and (x,y,z) coordinates of individual cells (called rechits) are provided as input to the model for training to the target  $E_{True}/E_{fix}$ . Loss function is defined as (target-prediction)<sup>2</sup>/target.

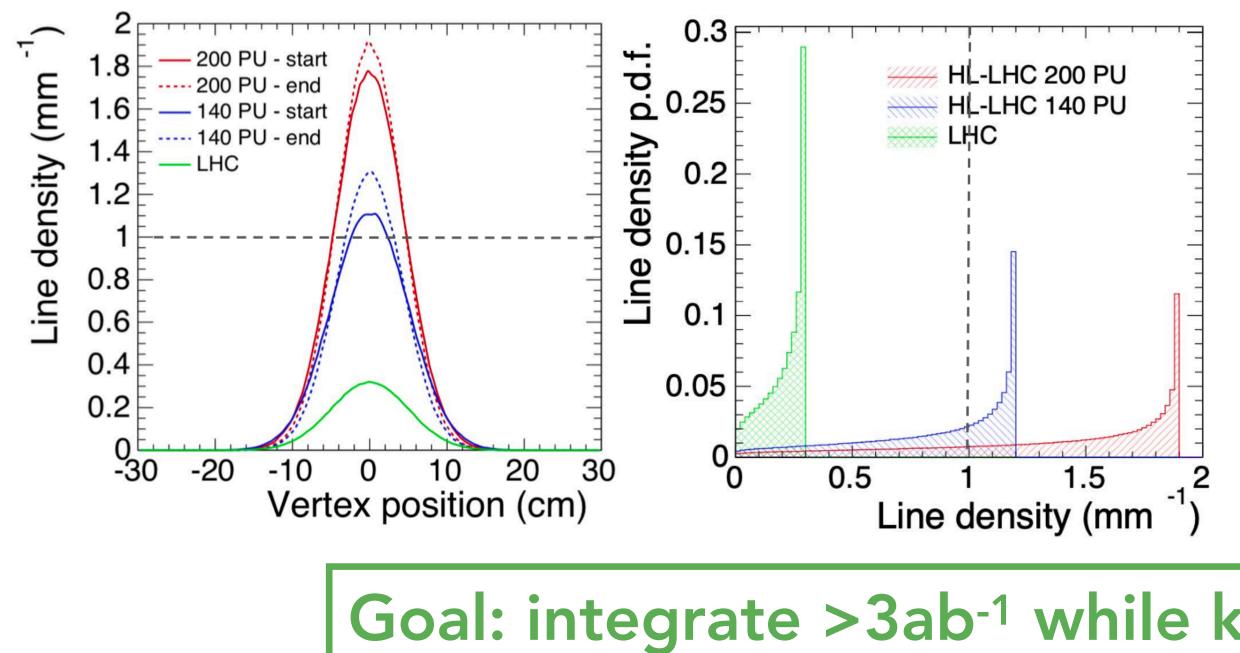


The model is trained on a flat energy sample of 10-350 GeV with a total of 4.1M events simulated using GEANT4.10.4.p03 and FTFP BERT EMN hadronic physics list. Out of 39 sampling layers of AHCAL, only 10 layers are sampled (consistent with the final HGCAL geometry). AdamW optimizer with a constant learning rate of 10<sup>-4</sup> is used. We have approximately 63k parameters to learn in the model and a larger fraction of model training time goes into aggregating the information.

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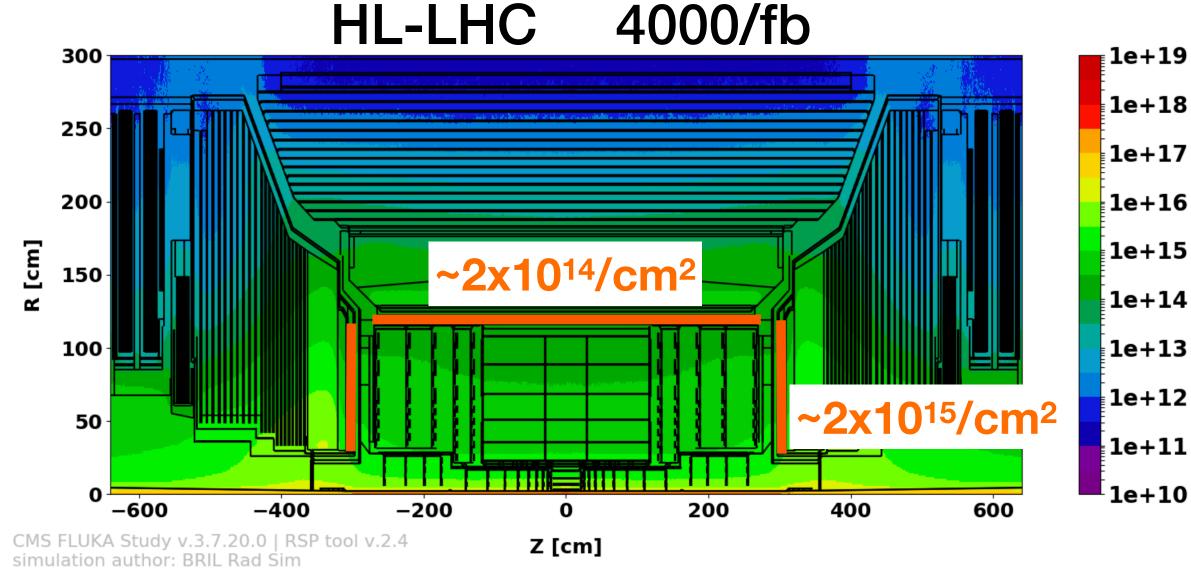
# High pileup

	Phase I LHC	HL-LHC
E <sub>beam</sub> (TeV)	7-13.6	14
$\mathcal{L}_{peak}$ (cm⁻² s⁻¹)	2 x 10 <sup>34</sup>	5-7.5 x 10 <sup>34</sup>
∫ <b>∠ (fb</b> <sup>-1</sup> )	300-500	3000-4000
PU	40-60	140-200



# High radiation

- Expected fluence up to several 10<sup>16</sup> n<sub>eq</sub>/cm<sup>2</sup> in the proximity of the beam pipe
- The annual dose is a factor **x10 higher** with respect to LHC

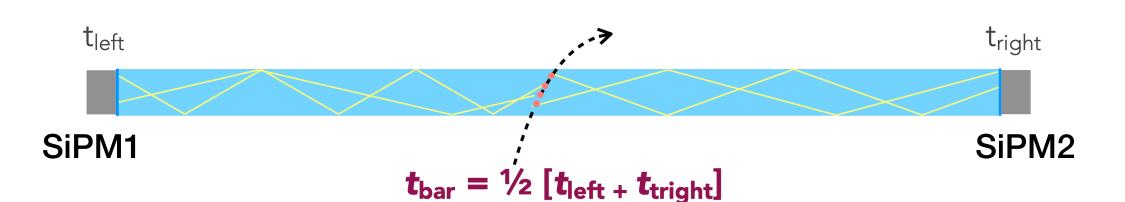


### Goal: integrate >3ab<sup>-1</sup> while keeping the current performance

- le+18 le+17 1e+16 🖧 1e+15 1e+14 le+13 le+12 le+11 le+10



## The BTL approach



### + High aspect ratio geometry + LYSO bars with double end readout: improve resolution by $\sqrt{2}$ over single-end

### • Detector Module:

- o 16 LYSO bars glued to 2 SiPM arrays (~165k crystals)
  - Time response independent from impact point
- Dedicated ASIC (TOFHIR) for processing and digitization of SiPM signal

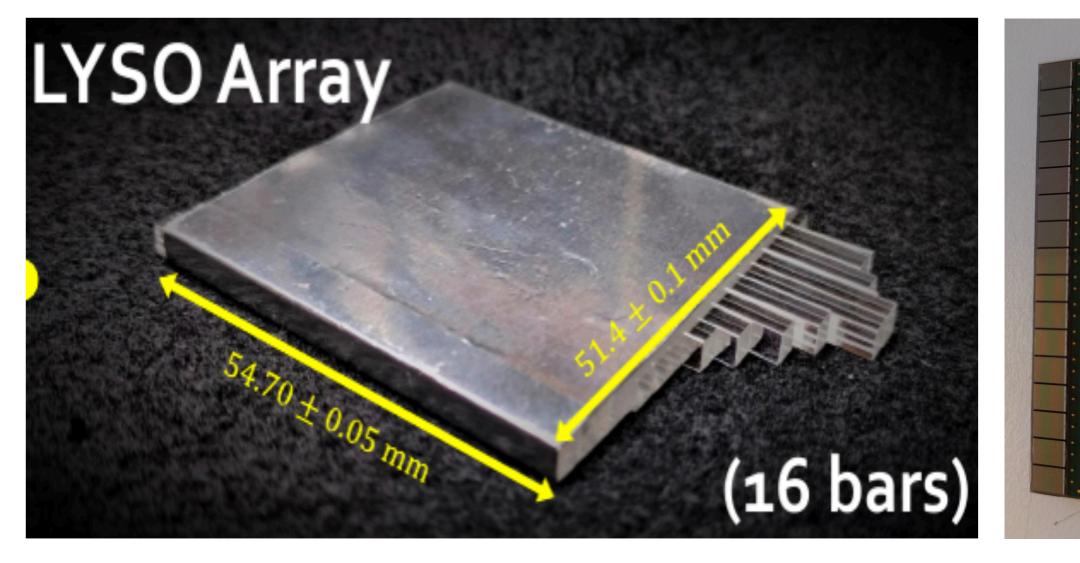
### Expect a Dark Count Rate (DCR) of O(10) GHz at end of operations due to SiPM radiation damage

### • LYSO

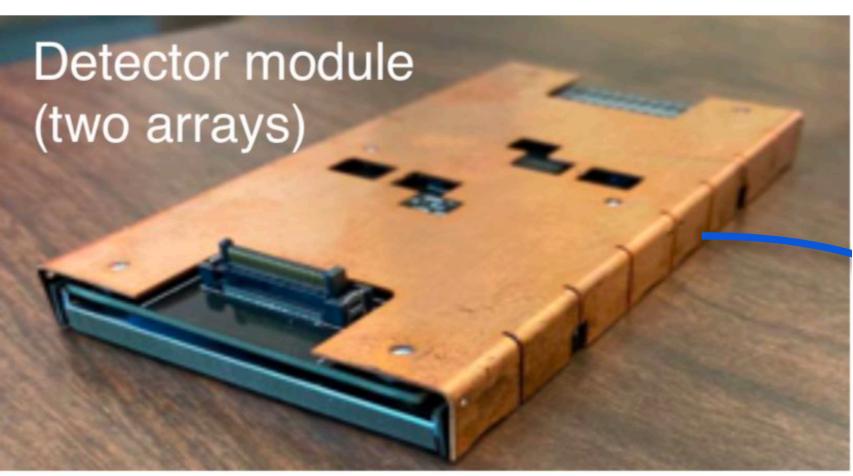
- $\tau_{\rm rise} \sim 100 \ {\rm ps}$ ,  $\tau_{\rm decay} \sim 40 \ {\rm ns}$
- LY ~40000  $\gamma$ /MeV

#### • SiPM

- Insensitive to B-field
- 20-40% PDE at LYSO emis. peak



~165k crystals) t point ng and





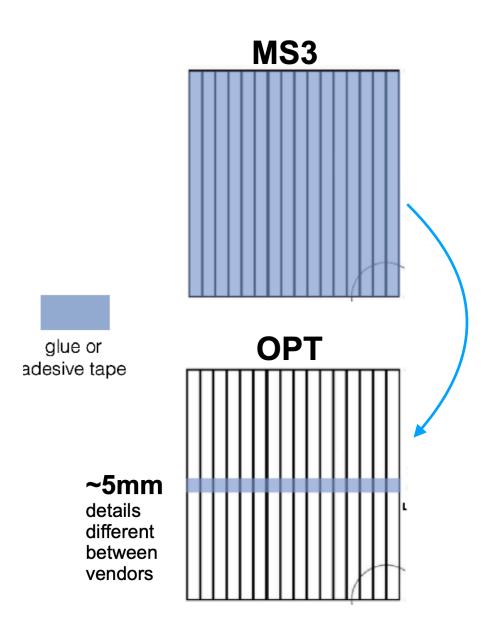


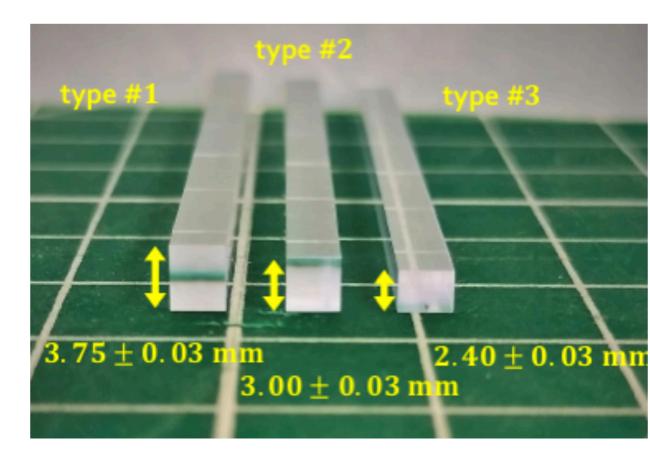


## Strategies to improve the S/N ratio

### Maximize the crystal light output

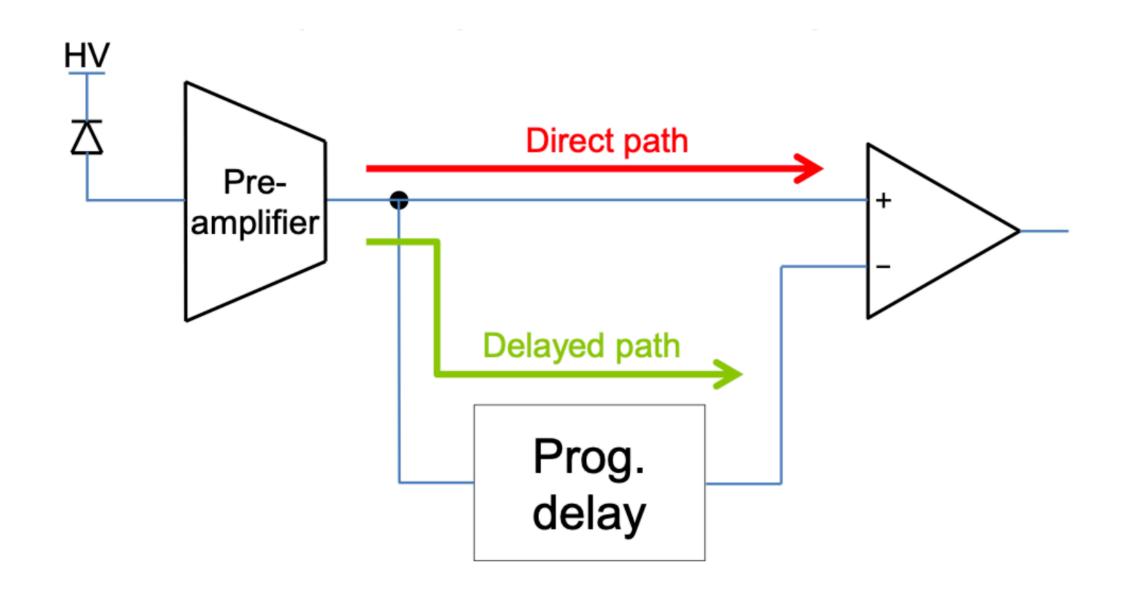
- Minimal amount of glue to improve the total internal reflection
  - 10% improvements in time resolution at EoO 0
- The option of thickening the LYSO bars is under investigation





### Noise filter + high electronics gain

- **DLED**: Sum the inverted and delayed signal  $\rightarrow$  cancel out correlated noise while preserving the rising edge
- **1.6x higher preamp gain** in the latest version of the TOFHIR

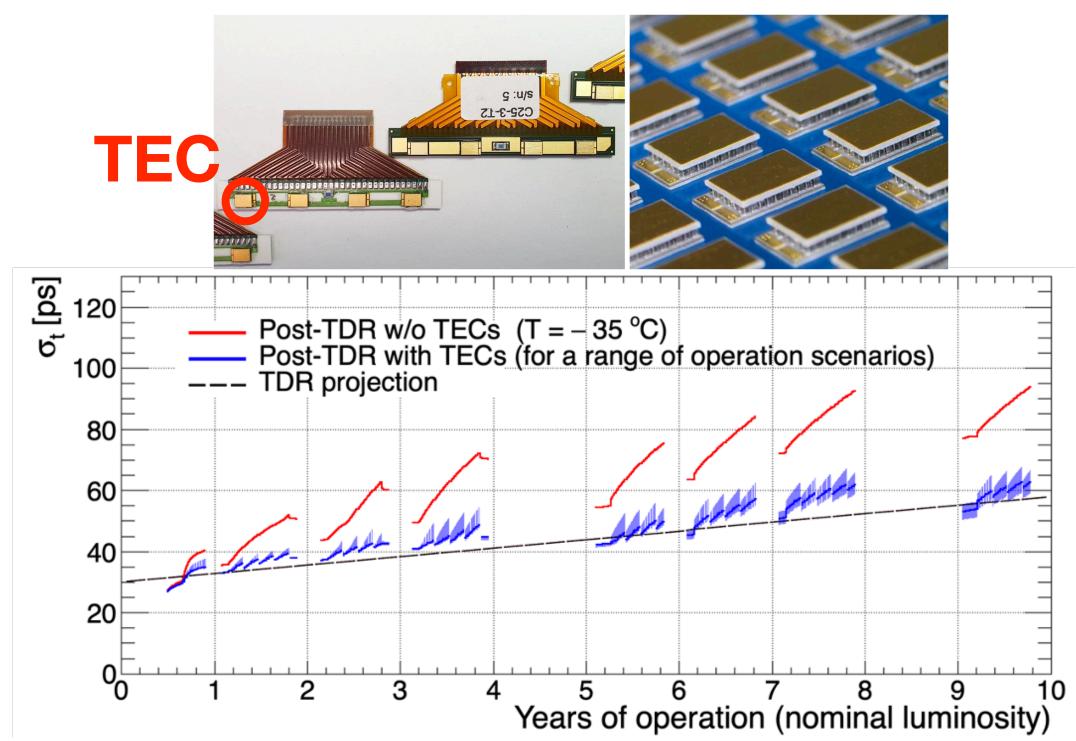


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## Strategies to improve the S/N ratio

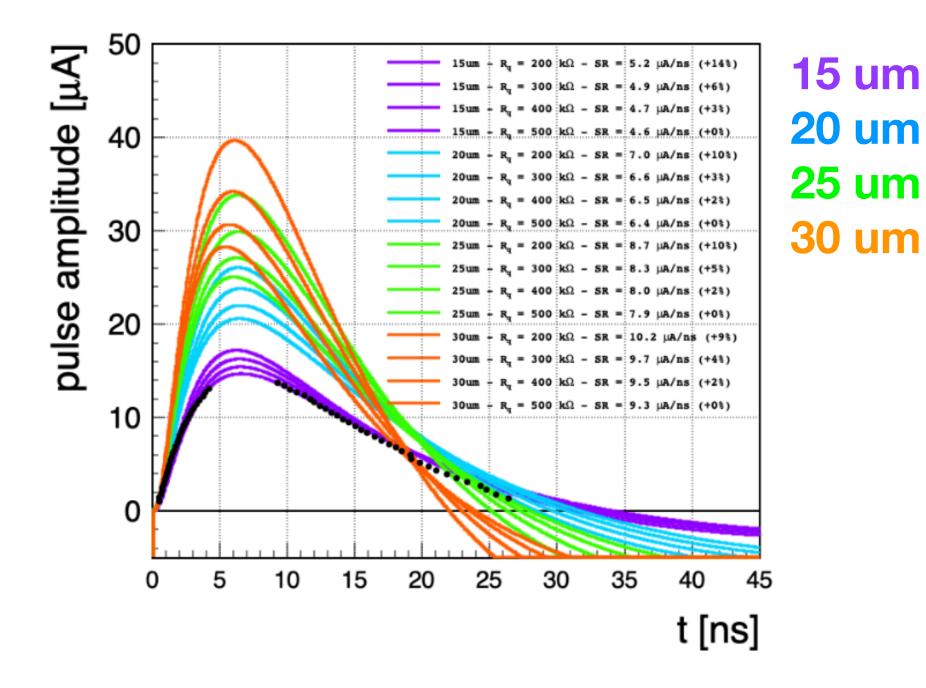
### Cold operations + SiPM annealing

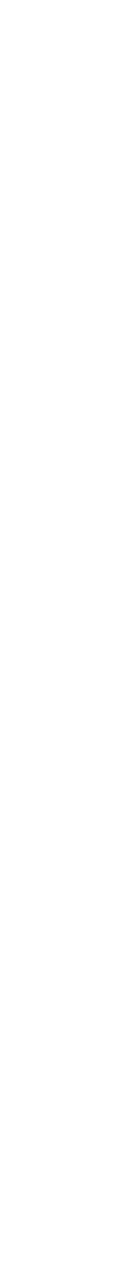
- CO2 cooling at -35°C + additional cooling down to -45°C using Thermo-Electric Coolers (TECs)
- In situ annealing cycles at +60°C during machine shutdowns



### Large signal from SiPMs

- SiPMs with **larger cell size** (15um  $\rightarrow$  30um)
  - Steeper rising edge → lower impact of electronics noise
  - Larger PDE  $\rightarrow$  lower impact of all resolution terms

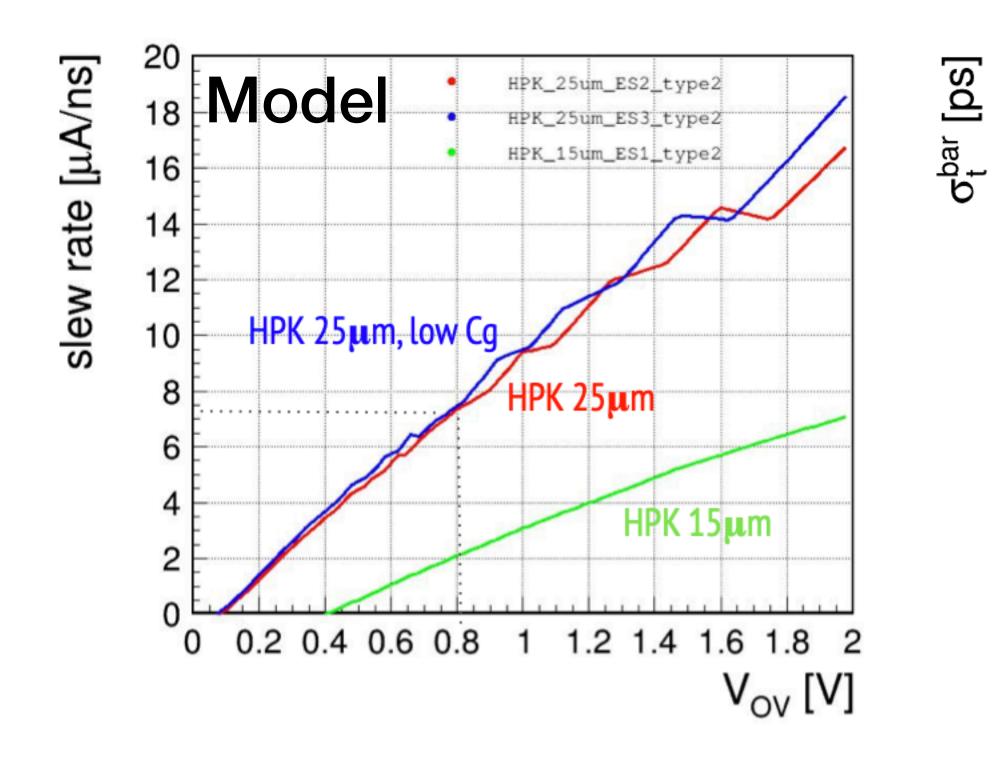




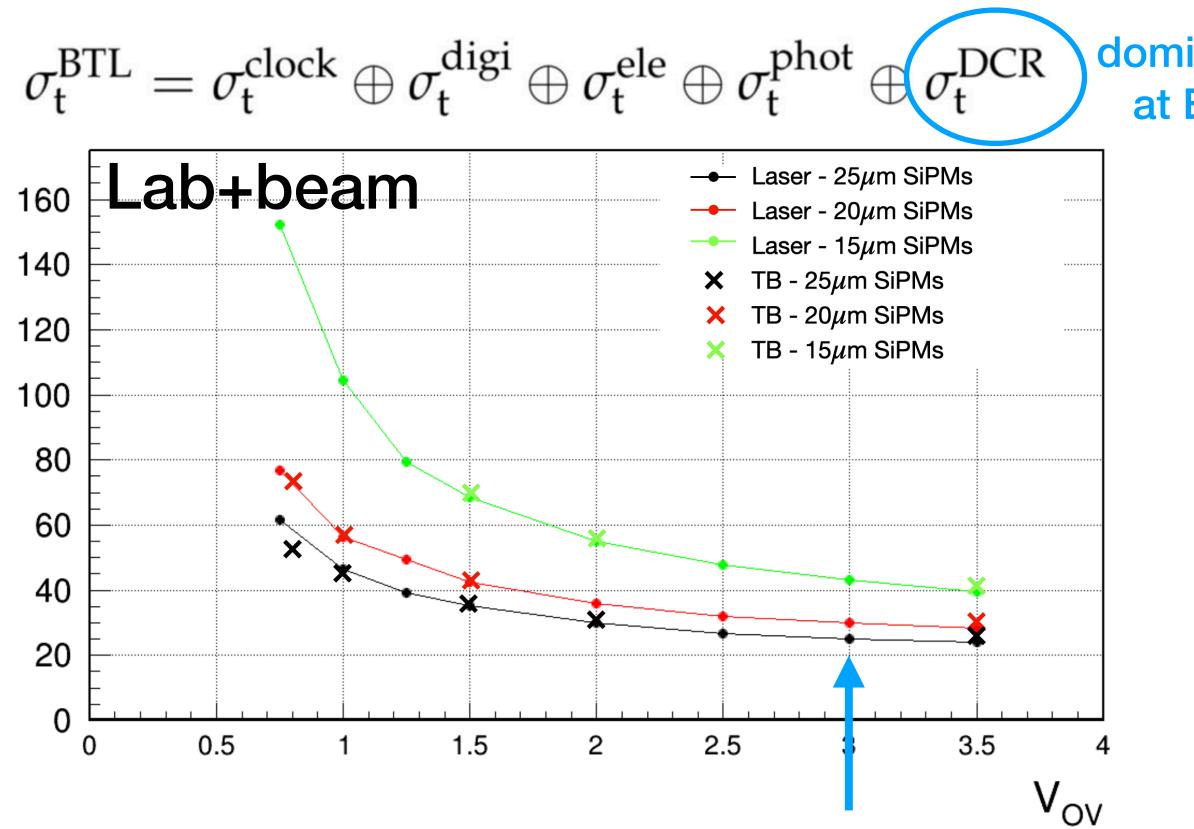


## Performance validation

- Careful modelling of the SiPM response and its evolution in time
- Extensive study of sensor prototypes in test beam and in the lab Results obtained with laser on LYSO have been validated on beam 0
- Startup performance and uniformity confirmed! Ongoing test beam on irradiated SiPMs.



More in Flavia's talk!



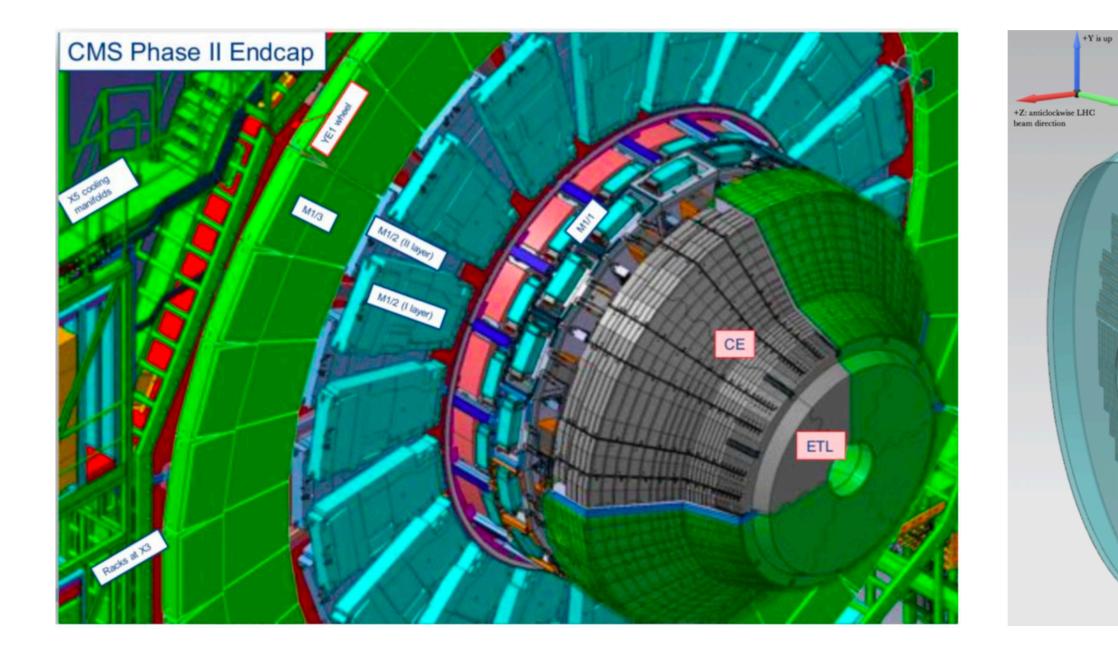


at EoO



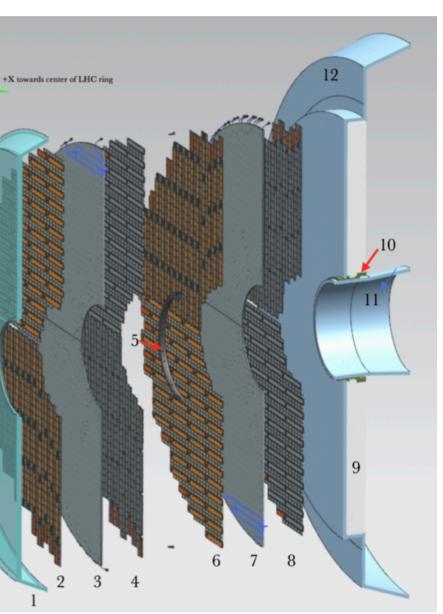
## The ETL approach

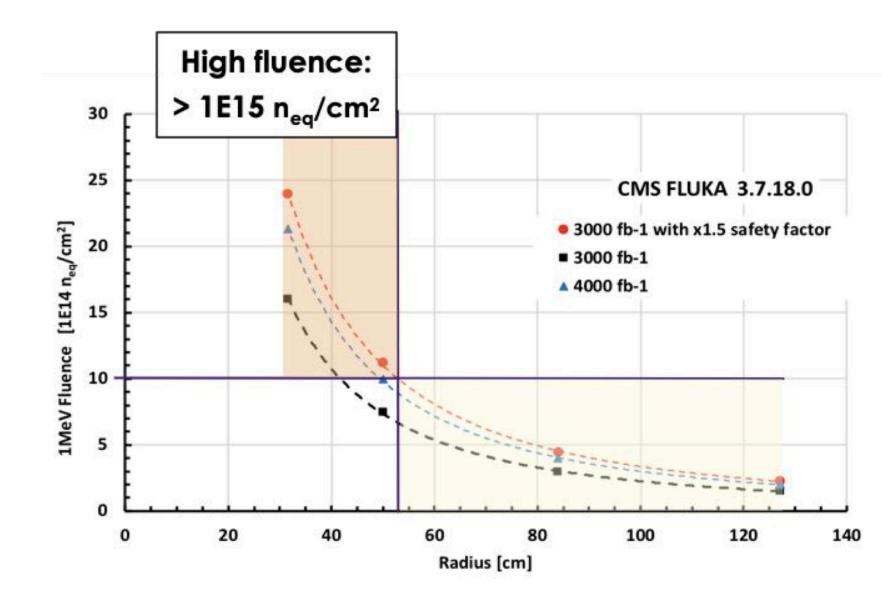
- 50 um thick silicon sensors based on the Low-Gain Avalanche Diode (LGAD) technology
- 2 double-sided disks for each endcap side
  - Will be mounted on the nose of the CMS CE calorimeter 0
  - Large geometrical acceptance (85%/disk) Ο
  - Ensure two hits for each track 0
- 12% of ETL surface will be exposed to fluences > 1x10<sup>15</sup> n<sub>eq</sub>/cm<sup>2</sup>



### Target time resolution

- single hit resolution < 50 ps
- track resolution < 35 ps



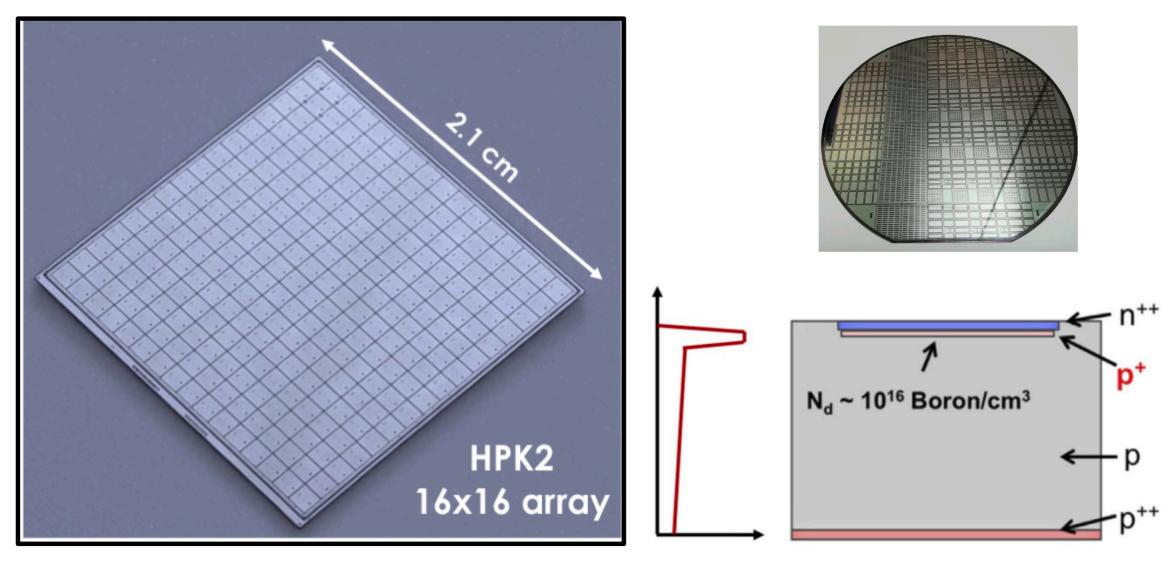








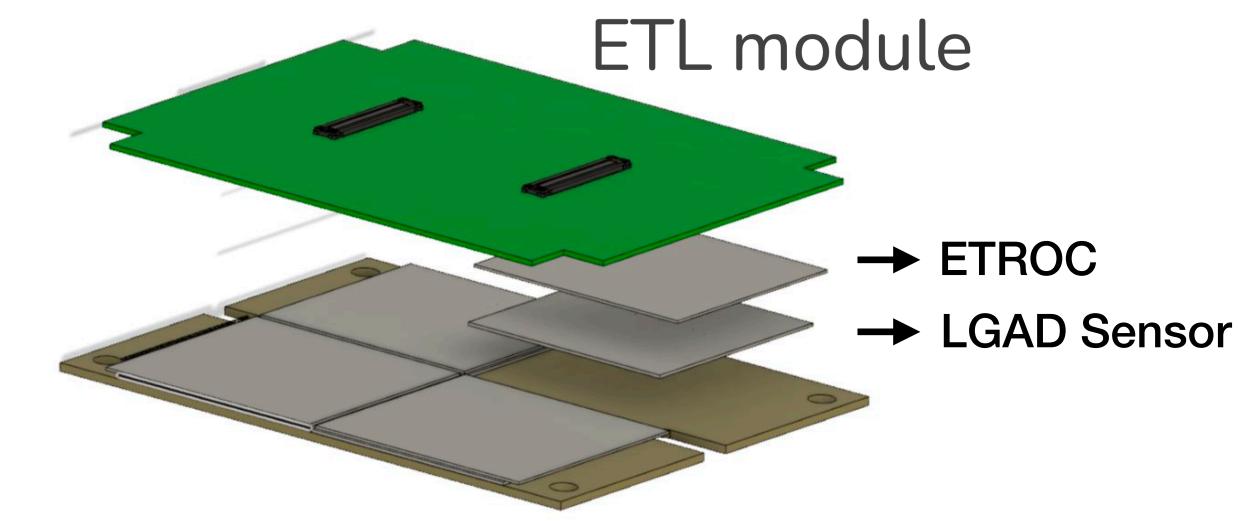
- 16x16 pad matrix LGAD o 1.3x1.3 mm<sup>2</sup> pad size
- Uniform gain (x20-30) and low leakage current
- $T_{res} = 30-40$  ps for bare sensor
  - >8 fC of charge until EoO



Low Gain Avalanche Diode

## Module

- ~8000 modules on 2 endcaps
- Sensor bump bonded to the readout ASIC (ETROC)
- Coverage:  $1.6 < |\eta| < 3.0, 0.31 \text{ m} < \text{R} < 1.2 \text{ m}$

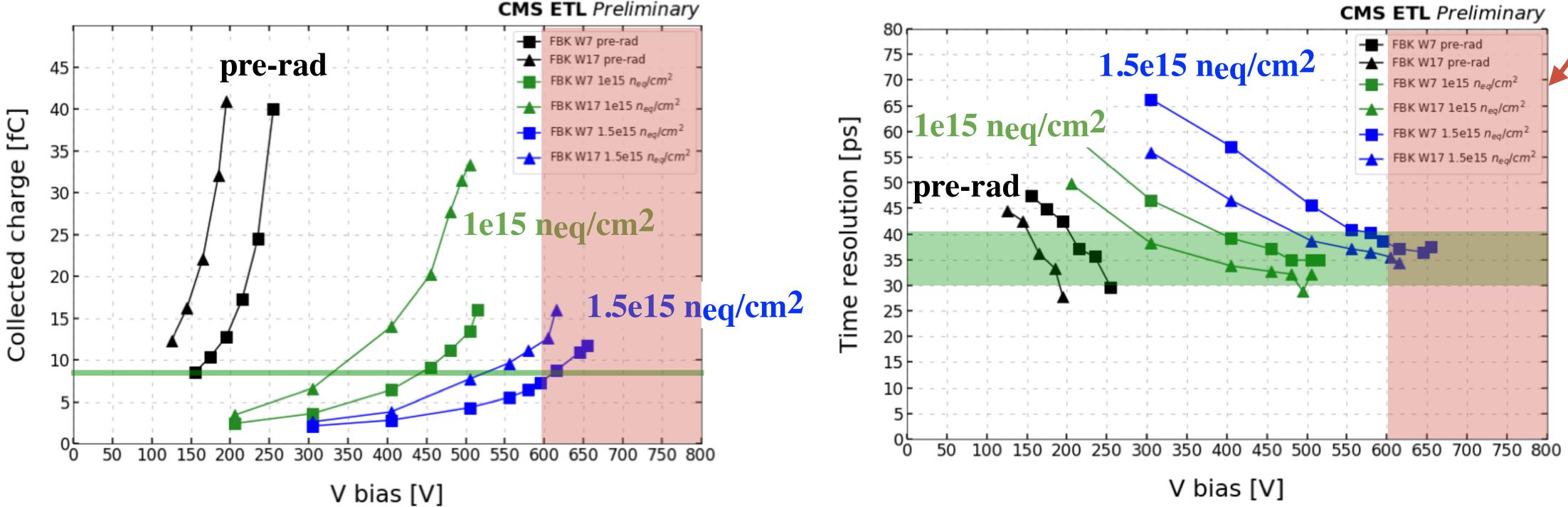


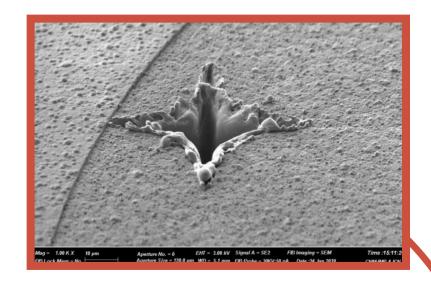




## Radiation hardness confirmed in the lab

- 55um irradiated sensors characterized with a beta-source (Sr90) setup
  - Collected charge and time resolution of the bare sensors is within requirements 0
  - Fully recover performance by increasing the bias voltage 0
- Single Event Burn-out observed for  $E_{bulk} > 11 V/\mu m$ 
  - No need to work in such extreme regimes



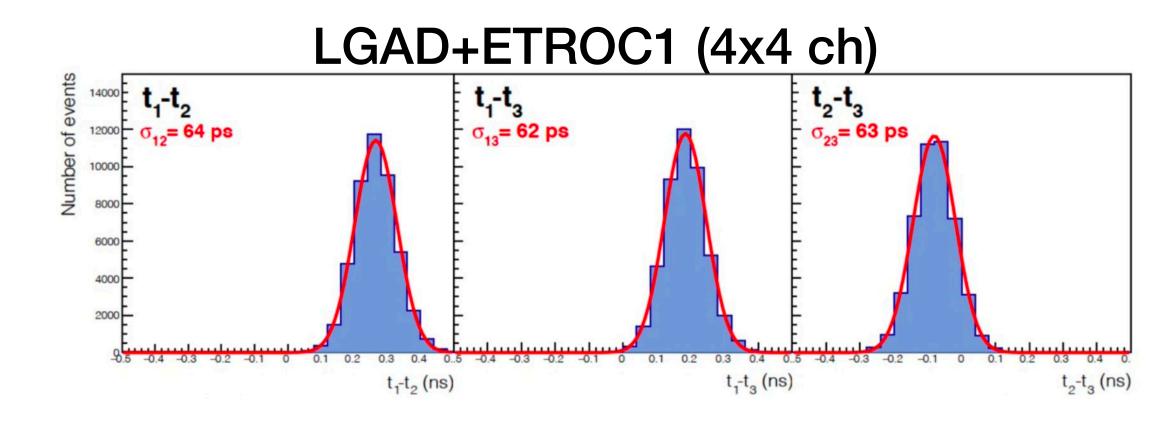






## Characterization on beam

- Full size 16x16 array tested on beam
  - Bare sensors:  $\sigma_{\rm f}$  ~30 ps and 100% efficiency
- Realistic readout with LGAD+ETROC1
  - First full system DAQ
  - o  $\sigma_{\rm f}$ ~45 ps
- ETROC2 (16x16) currently under test
  - Aim to submit the final chip (ETROC3) in 2024

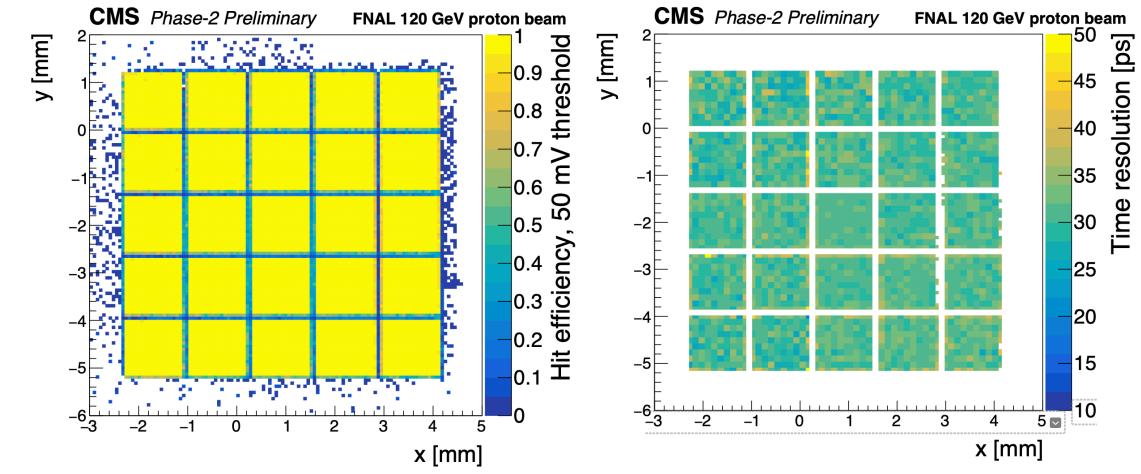


#### UZH-UCSC board used to stress test the final sensor (16x16 pads) in test beams and in the laboratory



**Readout board** RMS noise of the board = 2.4mV

### **BARE SENSORS**







### Phase-2 Tracker

#### Outer Tracker design driven by ability to provide tracks at 40 MHz to L1 trigger

- $\simeq 200 \text{ m}^2 200 \text{x} 10^6 \text{ channels}$

#### Inner tracker with extended coverage in pseudo-rapidity

